IntelliMAX[™] 3 A-Capable, Slew-Rate-Controlled Load Switch with True Reverse Current Blocking

FPF1048

Description

The FPF1048 advanced load management switch targets applications requiring a highly integrated solution. It disconnects loads powered from the DC power rail (<6 V) with stringent off-state current targets and high load capacitances (up to 100 μ F). The FPF1048 consists of slew-rate controlled lowimpedance MOSFET switch (23 m Ω typical) and integrated analog features. The slew-rate controlled turn-on characteristic prevents inrush current and the resulting excessive voltage droop on power rails.

The FPF1048 has a True Reverse Current Blocking (TRCB) function that obstructs unwanted reverse current from V_{OUT} to V_{IN} during both ON and OFF states. The exceptionally low off-state current drain (<1 μ A maximum) facilitates compliance with standby power requirements. The input voltage range operates from 1.5 V to 5.5 V_{DC} to support a wide range of applications in consumer, optical, medical, storage, portable, and industrial-device power management. Switch control is managed by a logic input (active HIGH) capable of interfacing directly with low-voltage control signal / General-Purpose Input / Output (GPIO) without an external pull-down resistor.

The device is packaged in advanced, fully "green" compliant, 1.0 mm x 1.5 mm, Wafer-Level Chip-Scale Package (WLCSP) with backside lamination.

Features

- Input Voltage Operating Range: 1.5 V to 5.5 V
- Typical R_{DS(ON)}:
 - 21 m Ω at V_{IN} = 5.5 V
 - 23 m Ω at V_{IN} = 4.5 V
 - 41 m Ω at V_{IN} = 1.8 V
 - 90 m Ω at V_{IN} = 1.5 V
- Slew Rate/Inrush Control with t_R: 2.7 ms (Typ.)
- 3 A Maximum Continuous Current Capability
- Low Off Switch Current: <1 μA
- True Reverse Current Blocking (TRCB)
- Logic CMOS IO Meets JESD76 Standard for
- GPIO Interface and Related Power Supply Requirements
- ESD Protected:
 - Human Body Model: >8 kV
 - Charged Device Model: >1.5 kV
 - IEC 61000–4–2 Air Discharge: >15 kV
 - IEC 61000–4–2 Contact Discharge: >8 kV
- This is a Pb–Free Device



WLCSP6 CASE 567RM

MARKING DIAGRAM



- RA = Device Code
- K = 2-Digits Lot Run Traceability Code
- &. = Pin One Dot
- &2 = 2-Digit Date Code
- &Z = Assembly Plant Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 11 of this data sheet.

Applications

- Smart Phones, Tablet PCs
- Storage, DSLR, and Portable Devices

Application Diagram

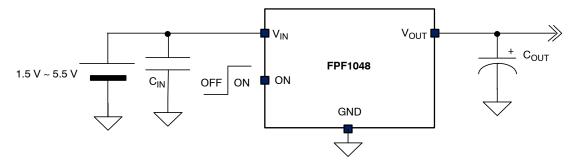


Figure 1. General Application

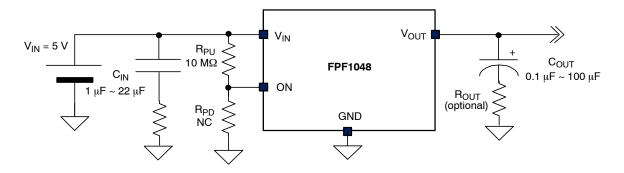
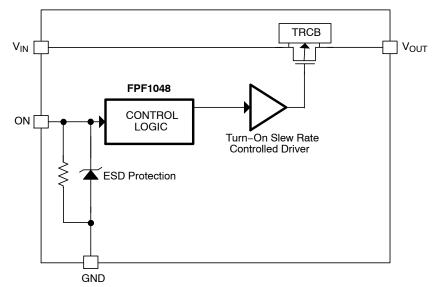


Figure 2. Specific Application with 10 M Ω Pull–Up Resistor at ON Pin

NOTES:

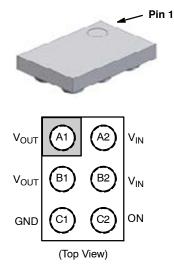
- 1. Turn-on operation with a 10 M Ω pull-up resistor at ON pin is acceptable. 2. V_{IN} should be high enough to generate V_{ON} greater than V_{IH} at the ON pin. 3. NC means no connection. 4. R_{IN} and R_{OUT} can be added to reduce transient peak voltage. 1 Ω ~ 10 Ω is recommended.

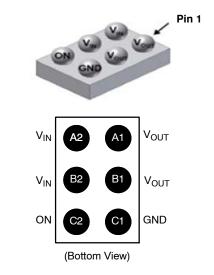
Functional Block Diagram





Pin Configurations







PIN DESCRIPTIONS

Pin #	Name	Description			
A1, B1	V _{OUT}	Switch Output			
A2, B2	V _{IN}	upply Input: Input to the Power Switch			
C1	GND	Ground			
C2	ON	ON/OFF Control, Active High, GPIO Compatible			

ABSOLUTE MAXIMUM RATINGS

Symbol			Min	Max	Unit	
V _{IN}	V _{IN} , V _{OUT} , V _{ON}	V _{IN} , V _{OUT} , V _{ON} to GND				V
I _{SW}	Maximum Con	tinuous Switch Cu	rrent	-	3.0	Α
PD	Power Dissipa	tion at T _A = 25°C		-	1.2	W
T _{STG}	Storage Juncti	rage Junction Temperature			+150	°C
T _A	Operating Tem	ting Temperature Range			+85	°C
θ_{JA}	Thermal Resistance, Junction to Ambient				85 (Note 5)	°C/M
			_	110 (Note 6)		
ESD	Electrostatic	Human Body Mc	odel, JESD22-A114	8.0	-	kV
	Discharge Capability Charged Device Model, JESD22-C101				-	
		IEC61000-4-2	Air Discharge (V _{IN} , V _{ON} , V _{OUT} to GND)	15.0	-	
		System Level	Contact Discharge (VIN, VON, VOUT to GND)	8.0	- 1	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality Should not be assumed, damage may occur and reliability may be affected.
Measured using 2S2P JEDEC std. PCB.
Measured using 2S2P JEDEC PCB cold plate method.

RECOMMENDED OPERATING RANGE

Symbol	Parameter		Тур	Мах	Unit
V _{IN}	Input Voltage	1.5	-	5.5	V
T _A	Ambient Operating Temperature	-40	-	+85	°C
I _{SW}	Continuous Switch Current	-	2.5	3	А

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

ELECTRICAL CHARACTERISTICS

(Unless otherwise noted, V_{IN} = 1.5 V to 5.5 V, T_A = -40 to +85°C, typical values are at V_{IN} = 4.5 V and T_A = 25°C.)

Symbol	Parameter Test Condition		Min	Тур	Max	Unit
BASIC OPE	RATION					
VIN	Input Voltage		1.5	-	5.5	V
I _{Q(OFF)}	Off Supply Current	V _{ON} = GND, V _{OUT} = Open	-	-	1	μA
I _{SD}	Shutdown Current	V_{ON} = GND, V_{OUT} = GND, T_A = -40 to +85°C	_	0.2	4.0	μA
lq	Quiescent Current	I _{OUT} = 0 mA	-	-	11	μA
R _{ON}	On-Resistance	V _{IN} = 5.5 V, I _{OUT} = 3 A (Note 7)	-	22.0	-	mΩ
		V _{IN} = 5.5 V, I _{OUT} = 2 A (Note 7)	_	21.5	-	
		V_{IN} = 5.5 V, I_{OUT} = 1 A, T_A = 25°C	_	21.0	28.0	
		V _{IN} = 4.5 V, I _{OUT} = 3 A (Note 7)	-	24.0	-	
		V _{IN} = 4.5 V, I _{OUT} = 2 A (Note 7)	_	23.5	-	
		V_{IN} = 4.5 V, I_{OUT} = 1 A, T_A = 25°C	-	23.0	30.0	
		V_{IN} = 3.3 V, I_{OUT} = 500 mA, T_A = 25°C	_	26.0	-	
		V_{IN} = 2.5 V, I_{OUT} = 500 mA, T_A = 25°C	-	30.0	-	
		V_{IN} = 1.8 V, I_{OUT} = 250 mA, T_A = 25°C	-	41.0	-	
		V_{IN} = 1.5 V, I_{OUT} = 250 mA, T_A = 25°C	_	90.0	110.0	
VIH	ON Input Logic High Voltage	V _{IN} = 1.5 V to 5.5 V	1.15	-	-	V
V _{IL}	ON Input Logic Low Voltage	V _{IN} = 1.8 V to 5.5 V	_	-	0.65	V
		V _{IN} = 1.5 V to 1.8 V	-	-	0.60	
I _{ON}	ON Input Leakage	V _{ON} = V _{IN} or GND	-	-	1.0	μA
$R_{ON_{PD}}$	Pull–Down Resistance at ON Pin	$V_{IN} = V_{ON} = 1.5 \text{ V to } 5.5 \text{ V}, T_A = -40^{\circ}\text{C} - +85^{\circ}\text{C}$	6.38	7.65	8.86	MΩ
RUE REVI	ERSE CURRENT BLOCKING		-	•	•	

RCB Protection Trip Point V_{OUT}-V_{IN} 45 V_{T_RCB} mV _ _ V_{R_RCB} **RCB** Protection Release Trip VIN-VOUT _ 25 _ mV Point **RCB** Hysteresis _ 70 _ mV VOUT Shutdown Current $V_{ON} = 0$, $V_{OUT} = 4.5$ V, $V_{IN} =$ Short to GND 2 μΑ ISD OUT _ _ $V_{OUT} - V_{IN}$ = 100 mV, V_{ON} = HIGH RCB Response Time, 4 _ _ μs t_{RCB_ON} Device ON $V_{OUT} - V_{IN}$ = 100 mV, V_{ON} = LOW RCB Response Time, _ 2.5 _ μs $t_{\rm RCB_OFF}$ Device OFF

DYNAMIC CHARACTERISTICS

t _{DON}	Turn-On Delay (Notes 8, 9)	V_{IN} = 4.5 V, R_L = 5 Ω,C_L = 100 $\mu F,T_A$ = 25°C	1	1.7	1	ms
t _R	V _{OUT} Rise Time (Notes 8, 9)		-	2.7	-	ms
t _{ON}	Turn-On Time (Notes 8, 9)		1	4.4	1	ms
t _{DON}	Turn-On Delay (Notes 8, 9)	V_{IN} = 4.5 V, R_L = 150 $\Omega,~C_L$ = 100 $\mu F,~T_A$ = 25°C	-	1.7	-	ms
t _R	V _{OUT} Rise Time (Notes 8, 9)		-	1.5	-	ms
t _{ON}	Turn-On Time (Notes 8, 9)		-	3.2	-	ms
t _{DOFF}	Turn-Off Delay (Notes 8, 10)	V_{IN} = 4.5 V, R_L = 150 $\Omega,~C_L$ = 100 $\mu F,~T_A$ = 25°C	-	1.8	-	ms
t _F	V _{OUT} Fall Time (Notes 8, 10)		-	34	-	ms
t _{OFF}	Turn-Off Time (Notes 8, 10)		-	35	-	ms

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

7. This parameter is guaranteed by the Lieutrica Characteristics in operated under differentiation of the production tested. 8. $t_{DON}/t_{DOFF}/t_R/t_F$ are defined in Figure 21. 9. $t_{ON} = t_R + t_{DON}$. 10. $t_{OFF} = t_F + t_{DOFF}$

TYPICAL CHARACTERISTICS

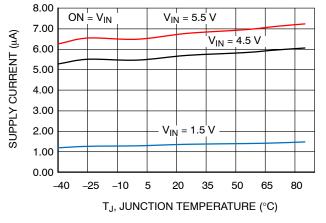


Figure 5. Supply Current vs. Temperature

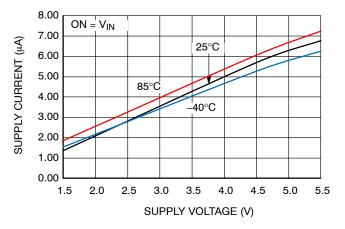


Figure 6. Supply Current vs. Supply Voltage

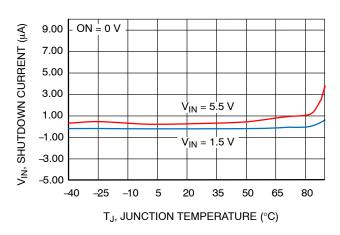


Figure 7. Shutdown Current vs. Temperature

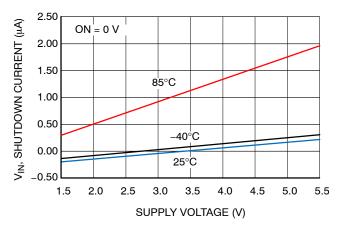
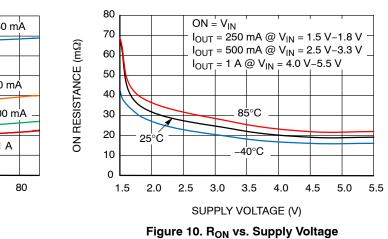
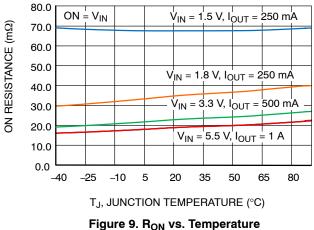


Figure 8. Shutdown Current vs. Supply Voltage





TYPICAL CHARACTERISTICS (continued)

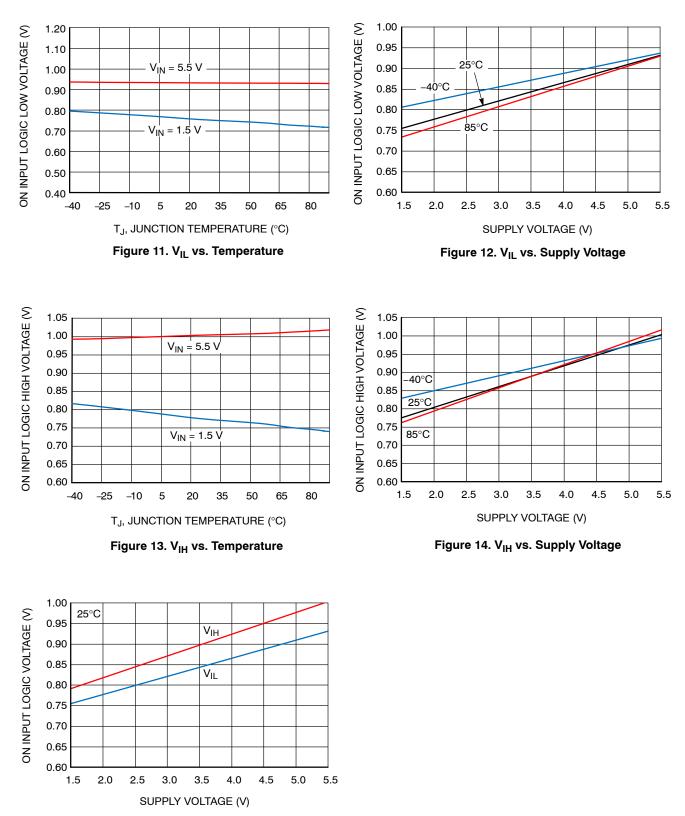
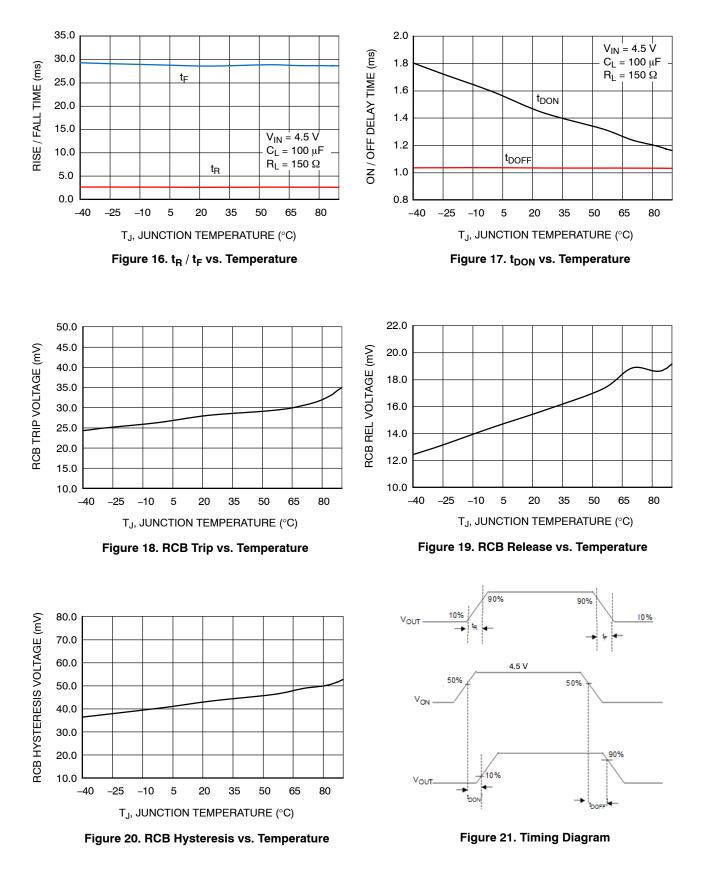


Figure 15. On Pin Threshold vs. Supply Voltage

TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

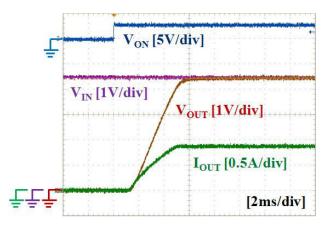


Figure 22. Turn–On Response (V_{IN} = 4.5 V, C_{IN} = 10 μ F, C_{OUT} = 100 μ F, R_L = 5 Ω)

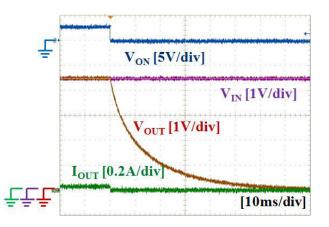
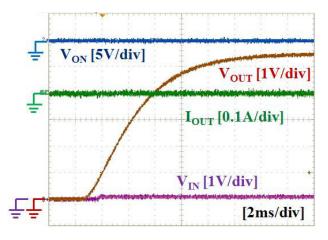
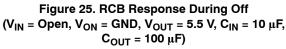


Figure 24. Turn–Off Response (V_IN = 4.5 V, C_IN = 10 $\mu\text{F},$ C_OUT = 100 $\mu\text{F},$ RL = 150 $\Omega)$





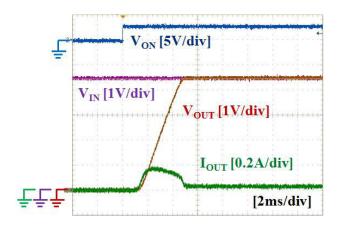
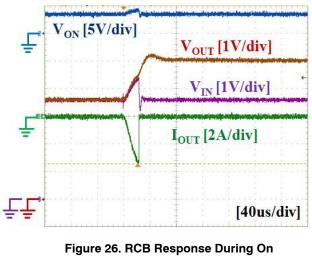
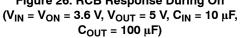


Figure 23. Turn–On Response (VIN = 4.5 V, CIN = 10 $\mu\text{F},$ COUT = 100 $\mu\text{F},$ RL = 150 $\Omega)$





Operation and Application Description

The FPF1048 is a low– R_{ON} P–channel load switch with controlled turn–on and True Reverse Current Blocking (TRCB). The core is a 23 m Ω P–channel MOSFET and controller capable of functioning over a wide input operating range of 1.5 V to 5.5 V. The ON pin, an active–HIGH, GPIO/CMOS–compatible input; controls the state of the switch. TRCB functionality blocks unwanted reverse current during both ON and OFF states when higher V_{OUT} than V_{IN} is applied.

Input Capacitor

To limit the voltage drop on the input supply caused by transient inrush current when the switch turns on into a discharged load capacitor; a capacitor must be placed between the V_{IN} and GND pins. At least 1 μ F ceramic capacitor, C_{IN}, placed close to the pins is usually sufficient. Higher–value C_{IN} can be used to reduce the voltage drop in higher–current applications.

Inrush Current

Inrush current occurs when the device is turned on. Inrush current is dependent on output capacitance and slew rate control capability, as expressed by:

$$I_{\text{INRUSH}} = C_{\text{OUT}} \times \frac{V_{\text{IN}} - V_{\text{INITIAL}}}{t_{\text{R}}} + I_{\text{LOAD}} \qquad (\text{eq. 1})$$

Where:

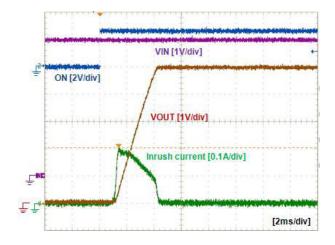
C _{OUT}	Ouput capacitance;
tR	Slew rate or rise time at V _{OUT} ;
V _{IN}	Input voltage;
V _{INITIAL}	Initial voltage at C _{OUT} , usually GND; and
I _{LOAD}	Load current.

Higher inrush current causes higher input voltage drop, depending on the distributed input resistance and input capacitance. High inrush current can cause problems.

FPF1048 has a 2.7 ms of slew rate capability under 4.5 V_{IN} at 1000 μ F of C_{OUT} and 5 Ω of RL so inrush current can be minimized and no input voltage drop appears. Table 1 and Figure 27 show the values and actual waveforms with C_{IN} = 10 μ F, C_{OUT} = 100 μ F, and no load current.

Table 1. INRUSH CURRENT BY INPUT VOLTAGE

		Inrush Current [mA]				
V _{IN} [V]	t _R [ms]	Measured	Calculated with 2.7 ms t _R			
1.5	1.62	76	56			
3.3	2.03	140	122			
5.0	2.33	196	185			



Output Capacitor

At least 0.1 μF capacitor, C_{OUT} , should be placed between the V_{OUT} and GND pins. This capacitor prevents parasitic board inductance from forcing V_{OUT} below GND when the switch is on.

True Reverse Current Blocking

The true reverse current blocking feature protects the input source against current flow from output to input regardless of whether the load switch is on or off.

Board Layout

For best performance, all traces should be as short as possible. To be most effective, the input and output capacitors should be placed close to the device to minimize the effect that parasitic trace inductance on normal and short–circuit operation. Using wide traces or large copper planes for all pins (V_{IN} , V_{OUT} , ON, and GND) minimizes the parasitic electrical effects and the case–to–ambient thermal impedance.

ORDERING INFORMATION

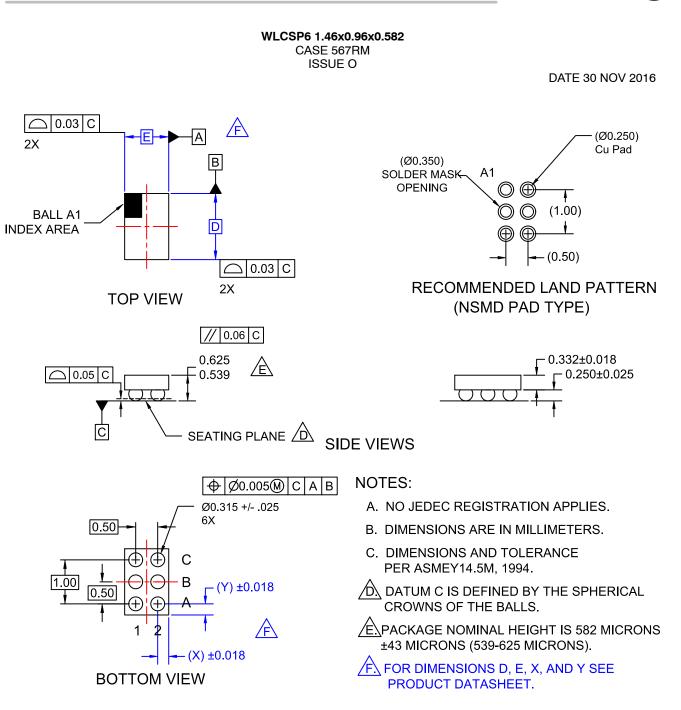
Part Numbe	r	Top Mark	Switch R _{ON} (Typical) at 4.5 V _{IN}	Input Buffer	Output Discharge	ON Pin Activity	t _R	Package
FPF1048BUC	X	RA	23 mΩ	CMOS	NA	Active HIGH	2.7 ms	6–Ball, WLCSP with Backside Laminate, 2 x 3 Array, 0.5 mm Pitch, 300 μm Balls

PRODUCT-SPECIFIC DIMENSIONS

Product	D	E	Х	Y
FPF1048BUCX	1460 μm ±30 μm	960 μm ±30 μm	230 μm	230 µm

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